

Company : Taiwan Semiconductor Manufacturing Company
Company Name : Taiwan Semiconductor Manufacturing Company
Nature Of Business : Semiconductor
Designation : IT Infrastructure Engineer
Tentative Job Location : Hsinchu City, Taiwan

Responsibilities

- 1.Responsible for one or multiple roles below:**
- IT Infrastructure related project management and architecture design
 - x86 Linux/Windows server and scale-out storage operation and management
 - Network operation and management.
 - Security product (ex: WAF, Firewall, Proxy, SLB, Anti-virus) and patch management.
 - Windows client management and services
 - Database Administrator
 - Docker container management using Kubernetes
- 2.Continuous improvement tasks for operation excellence**
- 3.IT new technology survey and adoption for productivity improvement**

Requirements

- 1.BS/MS degree or above and major in Computer Science, Information engineering, automation or electrical engineering or similar technical field with equivalent practical experience.**
- 2.Strong project management, communications, and interpersonal skills.**
- 3.Industry certifications such as Cisco CCNA/CCNP/CCDP/CCSP, VMware, RHCE, or Microsoft (MCSA, MCSE) are desired.**
- Description :**
- 4.Prefer experiences at least one field below:**
- Linux system management
 - Windows platform management
 - Azure AD and FQDN AD management
 - Relational database (DB2, Oracle, MSSQL) administration
 - SAN storage management
 - BigData management and operation
 - Network protocol, Cisco/HP network management.
 - Security product management experience (eg: WAF, Firewall, Proxy, SLB).
 - Virtual machine management using VMWare
 - Docker container management using Kubernetes

- 5.Passion for new technology adoption and operation excellence**

	Program	AE	BS	BE	CE	CHE	CSE	EE	ES	ME	MSE	PHY	CHM	MTH	ECO	DES	IME	CGS	HSS	EEM	MSP	NET	PSE	Stats
	BT	No	No		No	No	Yes	Yes	--	No	No	--	--	--	--	--	--	--	--	--	--	--	--	--
	BS	--	--		--	--	--	No	--	--	No	No	Yes	No	--	--	--	--	--	--	--	--	--	--
	MT	No	No		No	No	Yes	Yes	No	No	No	--	--	--	--	No	--	--	No	No	No	No	No	--
	DoubleMajor	No	No		No	No	Yes	Yes	--	No	No	No	No	Yes	No	--	--	--	--	--	--	--	--	--
	dual	No	No		No	No	Yes	Yes	No	No	No	No	No	Yes	No	--	--	--	--	--	--	--	--	--
Eligibility :	dualB	No	No		No	No	Yes	Yes	--	No	No	No	No	Yes	No	--	No	--	--	No	--	No	No	--
	dualC	No	No		No	No	Yes	Yes	No	No	No	No	No	Yes	No	No	No	--	--	--	--	--	--	--
	Mdes	--	--		--	--	--	--	--	--	--	--	--	--	--	No	--	--	--	--	--	--	--	--
	MBA	--	--		--	--	--	--	--	--	--	--	--	--	--	--	No	--	--	--	--	--	--	--
	Phd	No	No		No	No	Yes	Yes	No	No	No	No	No	Yes	No	No	No	No	No	No	No	No	No	Yes
	MSc	--	--		--	--	--	--	--	--	No	No	Yes	--	--	--	--	--	--	--	--	--	--	Yes
	MSR	No	No		No	No	Yes	Yes	--	No	No	--	--	--	--	--	--	No	--	--	--	--	No	--

	Item (Annual)	Bachelor Degree	Master Degree
Cost to Company :	GROSS	41,070	\$ 48,533
	CTC	43,637	\$ 51,566

Currency:USD

- Package Details :**
- Including 12 months base pay, 2 months Year-end bonus, 18 months Profit Sharing, 2 months relocation bonus, months of sign on bonus (depends on whether the offer has bond).**
 - Base Salary, Year-end bonus are fixed and recurring ; Profit Sharing is minimum amount for an average performance (i.e. top 50%) and recurring. ; Relocation and sign on bonus are one shot paid after onboard.**
 - Please note that the "Bond duration" is just for reference. The actual duration will depend on the offer that you get, it would be determined by your hiring manager.**

Bond : True
CPI CutOff : 0.0

Bond Details :	May have bond but it depends on further hiring assessment. (will be determined by the hiring manager)
Medical Requirments :	
Resume Shortlist :	True
Resume Shortlist Criteria:	N/A
Aptitude Test:	False
Group Discussion:	False
Technical Test:	False
Technical Interview:	True
Technical Interview Duration:	60 mins
Number of Techincal Interview Rounds:	1
HR Interview:	True
HR Interview Duration:	60 mins
Additional Information:	